Docket No.: 4590-523 PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of :

Pierre BLANCHARD : Confirmation No.7171

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U.S. Patent Application No. 10/582,711 : Group Art Unit: 2892

G. 35.P 7 ... 3

Filed: June 12, 2006 : Examiner: Jones, Eric W.

For: METHOD FOR PRODUCING ELECTRONIC CHIPS CONSISTING OF THINNED

SILICON

RESPONSE TO RESTRICTION REQUIREMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

By Official Action mailed April 24, 2008 restriction to one of the following inventions is required under 35 USC 121:

- I. Group I, claim(s) 16-25, drawn to a method for the fabrication of electronic chips from a semiconductor wafer comprising, on its front face, a thin active layer of semiconductor material.
- II. Group II, claim(s) 26-29, drawn to a color image sensor.

In response, Applicants hereby elect **Group I, claims 16-25** for examination in this case. This election is made <u>with traverse</u> - see below.